

HM730 / HM730F **400V N-Channel MOSFET**

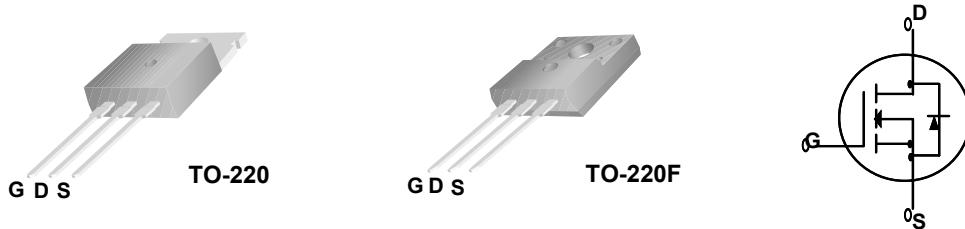
General Description

This Power MOSFET is produced using SL semi's advanced planar stripe DMOS technology.

This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency switched mode power supplies, active power factor correction based on half bridge topology.

Features

- 6.0A, 400V, $R_{DS(on)} = 1.00\Omega$ @ $V_{GS} = 10\text{ V}$
- Low gate charge (typical 18nC)
- Fast switching
- 100% avalanche tested
- Improved dv/dt capability



Absolute Maximum Ratings $T_C = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	HM730	HM730F	Units
V_{DSS}	Drain-Source Voltage	400		V
I_D	Drain Current - Continuous ($T_C = 25^\circ\text{C}$)	6.0	6.0*	A
	- Continuous ($T_C = 100^\circ\text{C}$)	3.6	3.6 *	A
I_{DM}	Drain Current - Pulsed	(Note 1)	24	A
V_{GSS}	Gate-Source Voltage		± 30	V
E_{AS}	Single Pulsed Avalanche Energy	(Note 2)	288	mJ
E_{AR}	Repetitive Avalanche Energy	(Note 1)	7.6	mJ
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	4.5	V/ns
P_D	Power Dissipation ($T_C = 25^\circ\text{C}$)	76	40	W
	- Derate above 25°C	0.6	0.32	W/ $^\circ\text{C}$
T_J, T_{STG}	Operating and Storage Temperature Range		-55 to +150	$^\circ\text{C}$
T_L	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds		300	$^\circ\text{C}$

* Drain current limited by maximum junction temperature.

Thermal Characteristics

Symbol	Parameter	HM730	HM730F	Units
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	1.64	3.13	$^\circ\text{C}/\text{W}$
$R_{\theta CS}$	Thermal Resistance, Case-to-Sink Typ.	0.5	--	$^\circ\text{C}/\text{W}$
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	62.5	62.5	$^\circ\text{C}/\text{W}$

Electrical Characteristics

$T_C = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
Off Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}$, $I_D = 250 \mu\text{A}$	400	--	--	V
$\Delta BV_{DSS} / \Delta T_J$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \mu\text{A}$, Referenced to 25°C	--	0.6	--	V/°C
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 400 \text{ V}$, $V_{GS} = 0 \text{ V}$	--	--	1	μA
		$V_{DS} = 320 \text{ V}$, $T_C = 125^\circ\text{C}$	--	--	10	μA
I_{GSSF}	Gate-Body Leakage Current, Forward	$V_{GS} = 30 \text{ V}$, $V_{DS} = 0 \text{ V}$	--	--	100	nA
I_{GSSR}	Gate-Body Leakage Current, Reverse	$V_{GS} = -30 \text{ V}$, $V_{DS} = 0 \text{ V}$	--	--	-100	nA

On Characteristics

$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250 \mu A$	2.0	--	4.0	V
$R_{DS(on)}$	Static Drain-Source On-Resistance	$V_{GS} = 10 V, I_D = 3.0 A$	--	0.83	1.0	Ω

Dynamic Characteristics

C_{iss}	Input Capacitance	$V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V},$ $f = 1.0 \text{ MHz}$	--	520	--	pF
C_{oss}	Output Capacitance		--	80	--	pF
C_{rss}	Reverse Transfer Capacitance		--	15	--	pF

Switching Characteristics

$t_{d(on)}$	Turn-On Delay Time	$V_{DD} = 200 \text{ V}, I_D = 6.0\text{A}, R_G = 25 \Omega$ (Note 4, 5)	--	10	--	ns
t_r	Turn-On Rise Time		--	60	--	ns
$t_{d(off)}$	Turn-Off Delay Time		--	20	--	ns
t_f	Turn-Off Fall Time		--	40	--	ns
Q_g	Total Gate Charge	$V_{DS} = 320 \text{ V}, I_D = 6.0 \text{ A}, V_{GS} = 10 \text{ V}$ (Note 4, 5)	--	18	-	nC
Q_{gs}	Gate-Source Charge		--	2.5	--	nC
Q_{gd}	Gate-Drain Charge		--	8.5	--	nC

Drain-Source Diode Characteristics and Maximum Ratings

I_S	Maximum Continuous Drain-Source Diode Forward Current		--	--	6.0	A
I_{SM}	Maximum Pulsed Drain-Source Diode Forward Current		--	--	24.0	A
V_{SD}	Drain-Source Diode Forward Voltage		$V_{GS} = 0 \text{ V}, I_S = 6.0 \text{ A}$	--	--	1.5
t_{rr}	Reverse Recovery Time	$V_{GS} = 0 \text{ V}, I_S = 6.0 \text{ A},$ $dI_F / dt = 100 \text{ A}/\mu\text{s}$	(Note 4)	250	--	ns
Q_{rr}	Reverse Recovery Charge			--	2.0	--

Notes:

1. Repetitive Rating : Pulse width limited by maximum junction temperature
 2. $L = 14\text{ mH}$, $I_{AS} = -6.0\text{ A}$, $V_{DD} = 50\text{ V}$, $R_G = 25\Omega$, Starting $T_J = 25^\circ\text{C}$
 3. $I_{SD} \leq 6.0\text{ A}$, $dI/dt \leq 200\text{A}/\mu\text{s}$, $V_{DD} \geq V_{BDS}$, Starting $T_J = 25^\circ\text{C}$
 4. Pulse Test : Pulse width $\leq 300\mu\text{s}$. Duty cycle $\leq 2\%$
 5. Essentially independent of operating temperature

Typical Characteristics

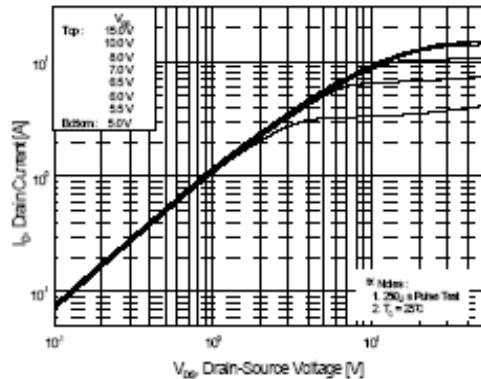


Figure 1. On-Region Characteristics

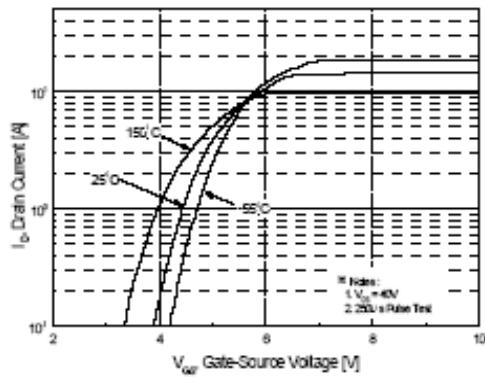


Figure 2. Transfer Characteristics

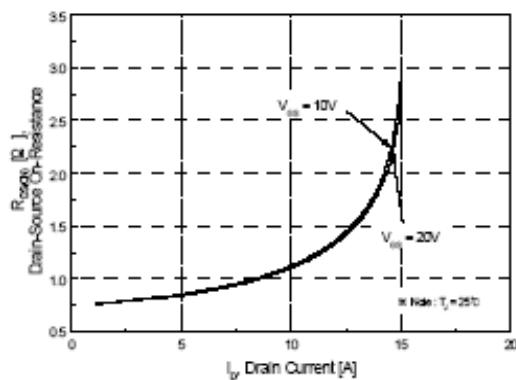


Figure 3. On-Resistance Variation vs
Drain Current and Gate Voltage

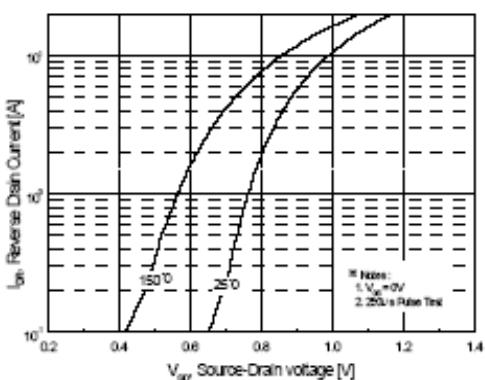


Figure 4. Body Diode Forward Voltage
Variation with Source Current

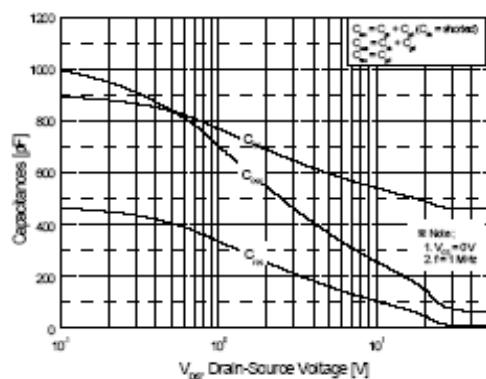


Figure 5. Capacitance Characteristics

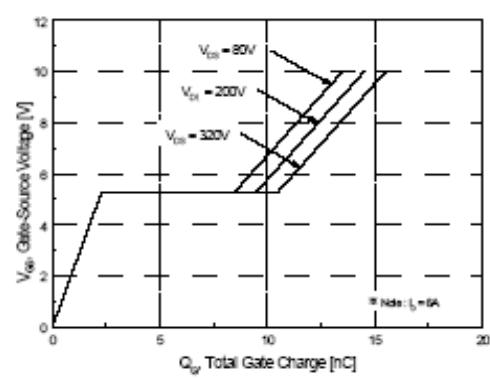
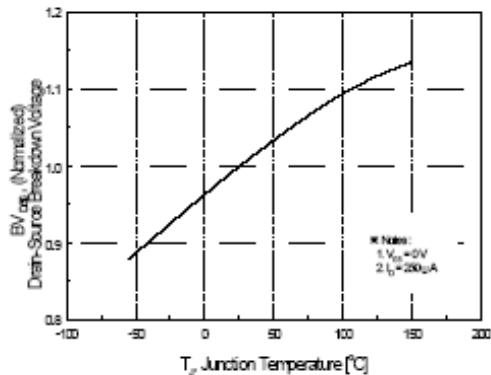
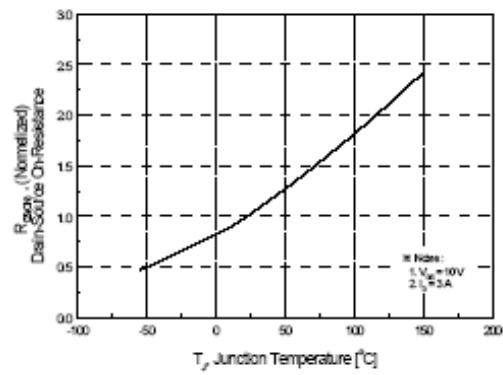


Figure 6. Gate Charge Characteristics

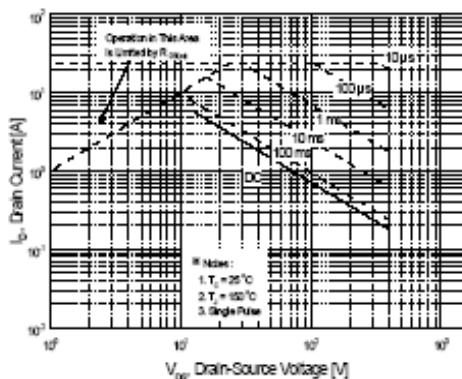
Typical Characteristics (Continued)



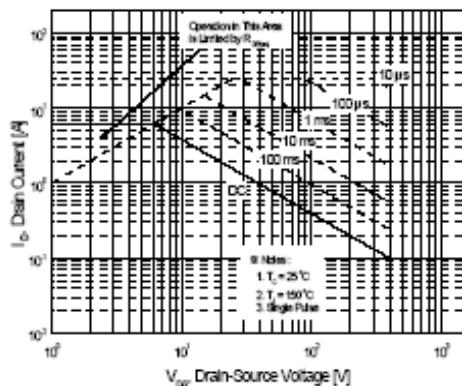
**Figure 7. Breakdown Voltage Variation
vs Temperature**



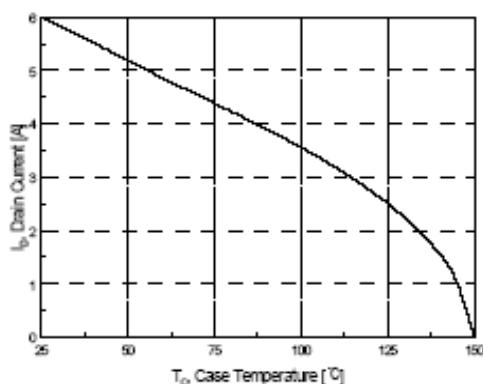
**Figure 8. On-Resistance Variation
vs Temperature**



**Figure 9-1. Maximum Safe Operating Area
for HM730**

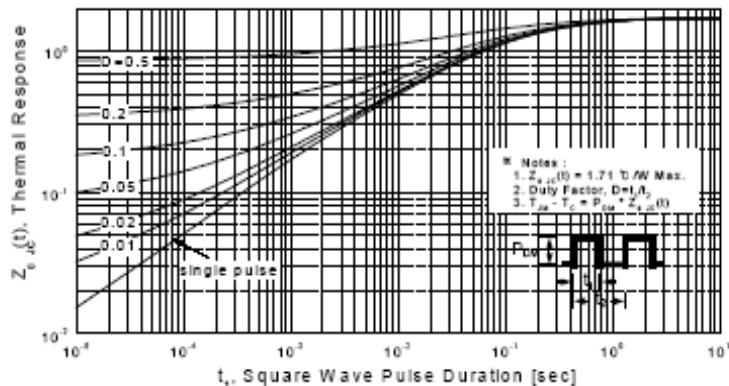


**Figure 9-2. Maximum Safe Operating Area
for HM730F**

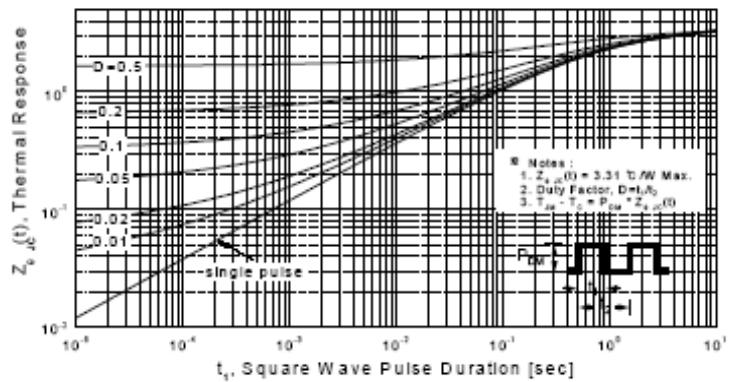


**Figure 10. Maximum Drain Current
vs Case Temperature**

Typical Characteristics (Continued)

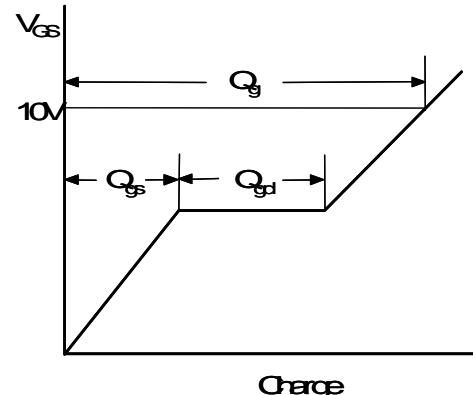
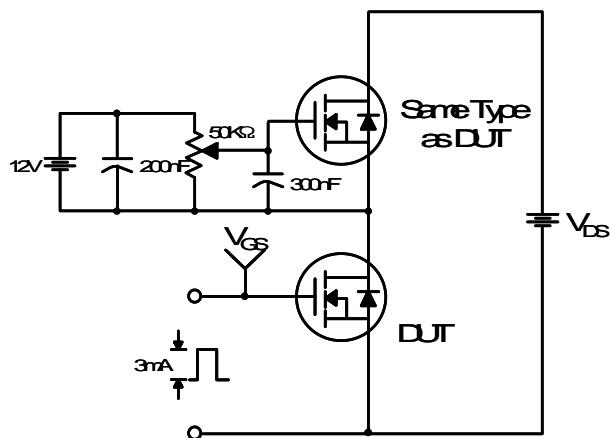


**Figure 11-1. Transient Thermal Response Curve
for HM730**

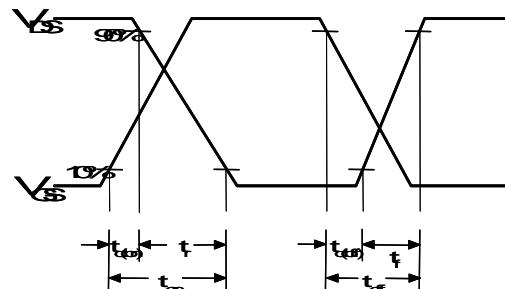
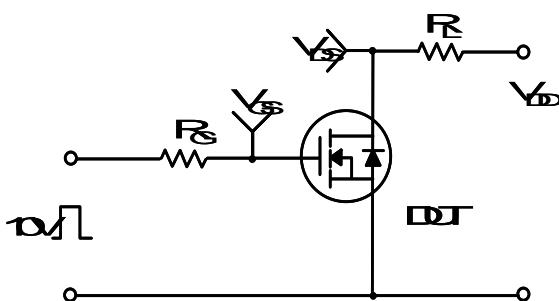


**Figure 11-2. Transient Thermal Response Curve
for HM730F**

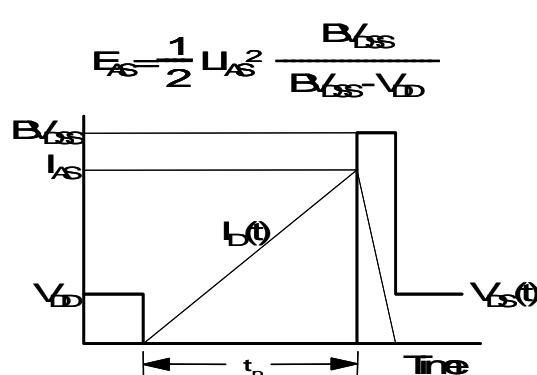
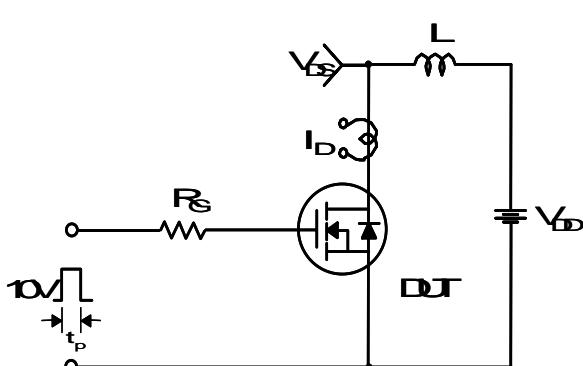
Gate Charge Test Circuit & Waveform



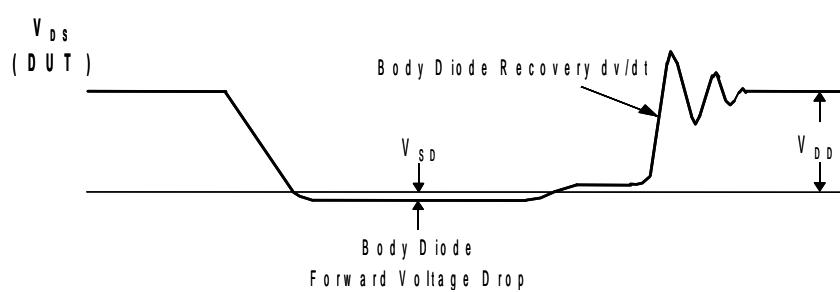
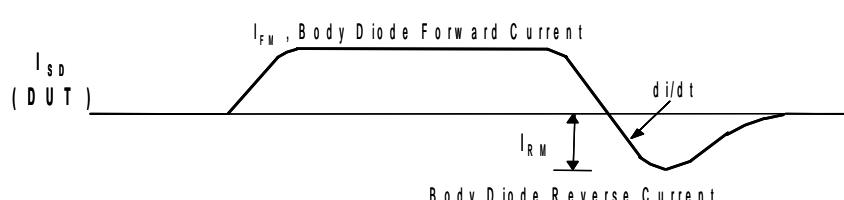
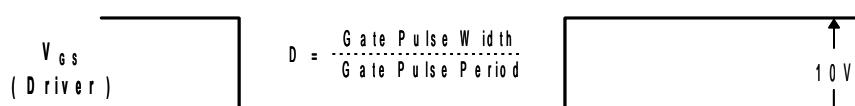
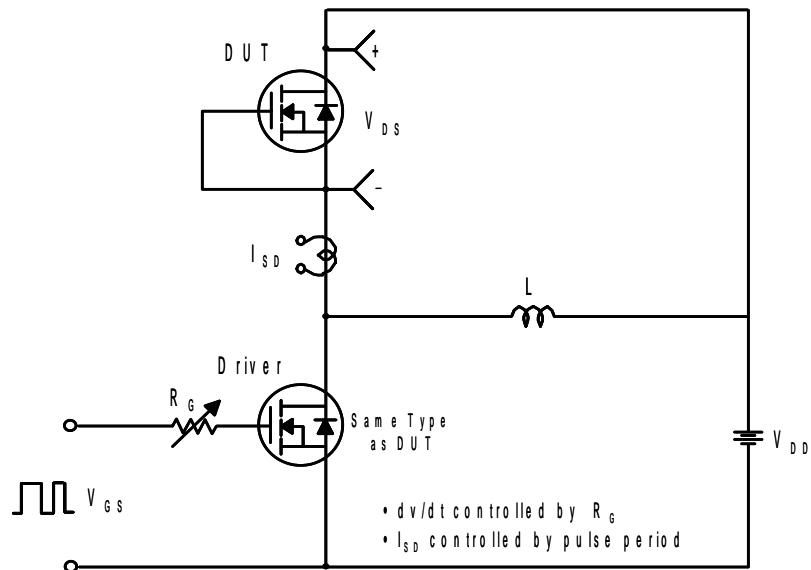
Resistive Switching Test Circuit & Waveforms



Unclamped Inductive Switching Test Circuit & Waveforms



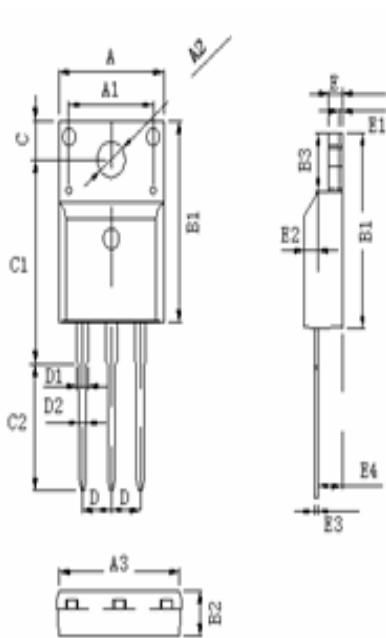
Peak Diode Recovery dv/dt Test Circuit & Waveforms



Package Dimensions

TO-220F

TO-220F 外形尺寸图



DIM.	MILLIMETERS
A	10.03 ± 0.20
A1	7.00
A2	3.12 ± 0.10
A3	9.70 ± 0.20
B1	15.75 ± 0.20
B2	4.72 ± 0.20
B3	6.70 ± 0.20
C	3.30 ± 0.10
C1	15.80 ± 0.20
C2	9.80 ± 0.2
D	Typical 2.54
D1	1.47 (MAX)
D2	0.80 ± 0.10
E	2.55 ± 0.20
E1	0.70
E2	1.00 × 45°
E3	0.50
E4	2.80 ± 0.20